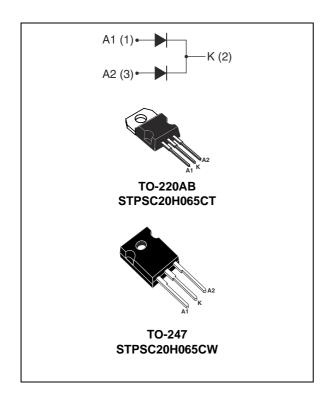


## STPSC20H065C

## 650 V power Schottky silicon carbide diode

Datasheet - production data



#### **Features**

- No or negligible reverse recovery
- Switching behavior independent of temperature
- Dedicated to PFC applications
- · High forward surge capability

#### **Description**

The SiC diode is an ultrahigh performance power Schottky diode. It is manufactured using a silicon carbide substrate. The wide band gap material allows the design of a Schottky diode structure with a 650 V rating. Due to the Schottky construction, no recovery is shown at turn-off and ringing patterns are negligible. The minimal capacitive turn-off behavior is independent of temperature.

Especially suited for use in PFC applications, this ST SiC diode will boost the performance in hard switching conditions. Its high forward surge capability ensures a good robustness during transient phases.

**Table 1. Device summary** 

Symbol	Value
I <sub>F(AV)</sub>	2 x 10 A
$V_{RRM}$	650 V
T <sub>j</sub> (max)	175 °C

Characteristics STPSC20H065C

### 1 Characteristics

Table 2. Absolute ratings (limiting values per diode at 25 °C unless otherwise specified)

Symbol	Para	Value	Unit	
$V_{RRM}$	Repetitive peak reverse voltage	650	V	
I <sub>F(RMS)</sub>	Forward rms current	22	Α	
1	Average forward current	$T_c = 135  ^{\circ}C^{(1)}$ , DC, per diode	10	۸
I <sub>F(AV)</sub>	Average forward current	T <sub>c</sub> = 125 °C <sup>(2)</sup> , per device	20	Α
	Curae non repetitive femuera	$t_p = 10 \text{ ms sinusoidal, } T_c = 25 \text{ °C}$		
I <sub>FSM</sub>	Surge non repetitive forward current	$t_p = 10 \text{ ms sinusoidal, } T_c = 125 \text{ °C}$	80	Α
	Current	$t_p = 10 \mu s \text{ square}, T_c = 25 \text{ °C}$	470	
I <sub>FRM</sub>	Repetitive peak forward current $T_c = 135  ^{\circ}C^{(1)}, T_j = 175  ^{\circ}C, \delta = 0.1$		36	Α
T <sub>stg</sub>	Storage temperature range	-55 to +175	°C	
T <sub>j</sub>	Operating junction temperature <sup>(3)</sup>	-40 to +175	°C	

- 1. Value based on  $R_{th(j-c)}$  max (per diode)
- 2. Value based on  $R_{\text{th(j-c)}}\,\text{max}$  (per device)
- 3.  $\frac{dPtot}{dT_j} < \frac{1}{Rth(j-a)}$  condition to avoid thermal runaway for a diode on its own heatsink

Table 3. Thermal resistance

Symbol	Parameter			Value		l lmi4
Symbol				Тур.	Max.	Unit
			TO-247	1.25	1.5	
В	lunation to appa per diada	Per diode	TO-220AB	1.23	1.5	
R <sub>th(j-c)</sub>	Junction to case per diode	Total	TO-247	0.83	0.05	°C/W
	Total		TO-220AB	0.03	0.95	
R <sub>th(c)</sub>	Coupling				0.4	

When the two diodes 1 and 2 are used simultaneously:

 $\Delta T_i$ (diode 1) = P(diode 1) x R<sub>th(j-c)</sub>(Per diode) + P(diode 2) x R<sub>th(c)</sub>

Table 4. Static electrical characteristics per diode

Symbol	Parameter	Tests conditions		Min.	Тур.	Max.	Unit
I <sub>R</sub> <sup>(1)</sup>	Pavarsa laakaga current	T <sub>j</sub> = 25 °C	$V_R = V_{RRM}$	-	9	100	μΑ
'R ` ′	I <sub>R</sub> (1) Reverse leakage current	T <sub>j</sub> = 150 °C		-	85	425	
V <sub>F</sub> <sup>(2)</sup>	Forward voltage drop	T <sub>j</sub> = 25 °C	I <sub>F</sub> = 10 A	-	1.56	1.75	V
V <sub>F</sub> · · · · · · · · · · · · · · · · · · ·	T <sub>j</sub> = 150 °C	IF = 10 A	F = 10 A	1.98	2.5	'	

<sup>1.</sup>  $t_p = 10 \text{ ms}, \delta < 2\%$ 

To evaluate the conduction losses use the following equation:

$$P = 1.35 \text{ x } I_{F(AV)} + 0.115 \text{ x } I_{F^2(RMS)}$$



<sup>2.</sup>  $t_p = 500 \ \mu s, \ \delta < 2\%$ 

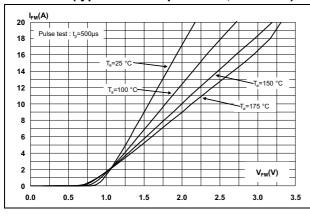
STPSC20H065C Characteristics

Symbol	Parameter	Test conditions	Тур.	Unit
Q <sub>cj</sub> <sup>(1)</sup>	Total capacitive charge	V <sub>R</sub> = 400 V	28.5	nC
C	Total capacitance	$V_R = 0 \text{ V}, T_c = 25 \text{ °C}, F = 1 \text{ MHz}$	480	pF
C <sub>j</sub> Total capacitance	$V_R = 400 \text{ V}, T_c = 25 \text{ °C}, F = 1 \text{ MHz}$	48	рг	

<sup>1.</sup> Most accurate value for the capacitive charge:  $Q_{cj} = \int_{0}^{v_{OUT}} c_{j}^{v_{OUT}} dv_{R}$ 

Figure 1. Forward voltage drop versus forward current (typical values per diode, low level)

Figure 2. Forward voltage drop versus forward current (typical values per diode, high level)



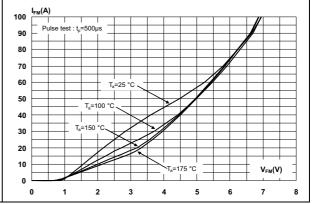
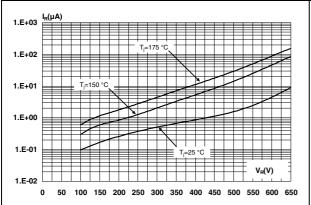
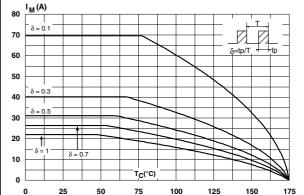


Figure 3. Reverse leakage current versus reverse voltage applied (typical values per diode)

Figure 4. Peak forward current versus case temperature, per diode

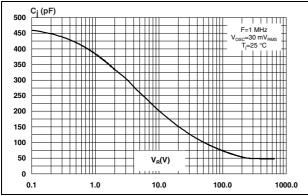




Characteristics STPSC20H065C

Figure 5. Junction capacitance versus reverse voltage applied (typical values, per diode)

Figure 6. Relative variation of thermal impedance junction to case versus pulse duration per diode



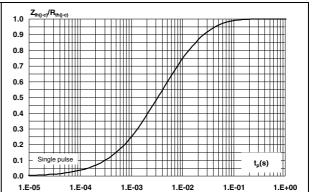
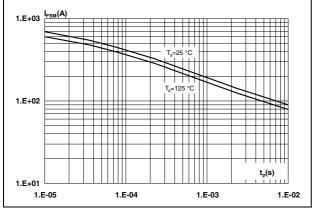
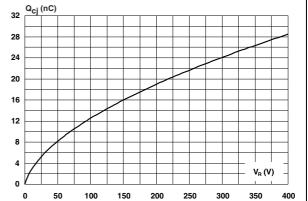


Figure 7. Non-repetitive peak surge forward current versus pulse duration per diode (sinusoidal waveform)

Figure 8. Total capacitive charges versus reverse voltage applied (typical values per diode)





## 2 Package information

- Epoxy meets UL94, V0
- Cooling method: conduction (C)
- Recommended torque value:
  - TO-220AB 0.4 to 0.6 N⋅m,
  - TO-247 0.55 N⋅m (1.0 N⋅m maximum)

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK<sup>®</sup> packages, depending on their level of environmental compliance. ECOPACK<sup>®</sup> specifications, grade definitions and product status are available at: <a href="https://www.st.com">www.st.com</a>. ECOPACK<sup>®</sup> is an ST trademark.

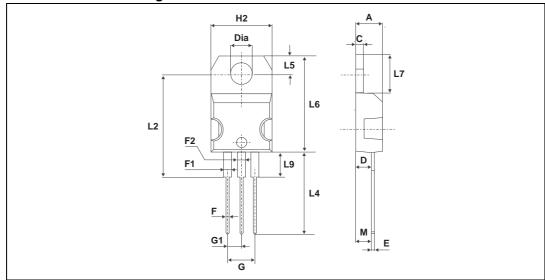


Figure 9. TO-220AB dimension definitions

Package information STPSC20H065C

Table 6. TO-220AB dimension values

	Dimensions					
Ref.	Millim	neters	Inches			
	Min.	Max.	Min.	Max.		
Α	4.40	4.60	0.173	0.181		
С	1.23	1.32	0.048	0.051		
D	2.40	2.72	0.094	0.107		
E	0.49	0.70	0.019	0.027		
F	0.61	0.88	0.024	0.034		
F1	1.14	1.70	0.044	0.066		
F2	1.14	1.70	0.044	0.066		
G	4.95	5.15	0.194	0.202		
G1	2.40	2.70	0.094	0.106		
H2	10	10.40	0.393	0.409		
L2	16.4	typ.	0.645 typ.			
L4	13	14	0.511	0.551		
L5	2.65	2.95	0.104	0.116		
L6	15.25	15.75	0.600	0.620		
L7	6.20	6.60	0.244	0.259		
L9	3.50	3.93	0.137	0.154		
М	2.6 typ.		0.102 typ.			
Diam.	3.75	3.85	0.147	0.151		

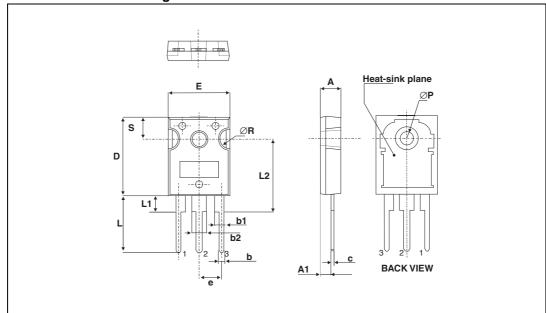


Figure 10. TO-247 dimension definitions

Table 7. TO-247 dimension values

			Dime	nsions		
Ref.	Millimeters			Inches		
	Min.	Тур.	Max.	Min.	Тур	Max.
А	4.85		5.15	0.191		0.203
A1	2.20		2.60	0.086		0.102
b	1.00		1.40	0.039		0.055
b1	2.00		2.40	0.078		0.094
b2	3.00		3.40	0.118		0.133
С	0.40		0.80	0.015		0.031
D <sup>(1)</sup>	19.85		20.15	0.781		0.793
Е	15.45		15.75	0.608		0.620
е	5.30	5.45	5.60	0.209	0.215	0.220
L	14.20		14.80	0.559		0.582
L1	3.70		4.30	0.145		0.169
L2	18.50 typ.				0.728 typ.	
ØP <sup>(2)</sup>	3.55		3.65	0.139		0.143
ØR	4.50		5.50	0.177		0.217
S	5.30	5.50	5.70	0.209	0.216	0.224

<sup>1.</sup> Dimension D plus gate protrusion does not exceed 20.5 mm

<sup>2.</sup> Resin thickness around the mounting hole is not less than 0.9 mm

Ordering information STPSC20H065C

# 3 Ordering information

**Table 8. Ordering information** 

Order code	Marking	Package	Weight	Base qty	Delivery mode
STPSC20H065CT	STPSC20H065C	TO-220AB	1.86 g	50	Tube
STPSC20H065CW	STPSC20H065CW	TO-247	4.43 g	30	Tube

# 4 Revision history

Table 9. Document revision history

Date	Revision	Changes	
31-Aug-2012	1	First issue.	
10-Oct-2012	2	Added Max. values to <i>Table 3</i> .	
07-Nov-2013	3	Updated Figure 1 and Figure 2.	

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